

Final Product Change Notification

Issue Date: 12-Sep-2015 Effective Date: 25-Dec-2015

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For detailed information we invite you to view this notification online

201505008F01



Management Summary

Transfer 74AHC/T & 74VHC/T products into released and mature C125 process at ICN8 and ASMC diffusion fabs

Change Category

X	Wafer Fab	process [Assembly	/ Process	X] Product	Marking	[X] Design

[] Wafer Fab materials [] Assembly Materials [] Electrical spec./Test coverage [] Mechanical Specification [X] Wafer Fab location [] Assembly Location [] Test Location [] Packing/Shipping/Labeling

Transfer AHC/T & VHC/T products into released and mature C125 process at ICN8 / ASMC

Details of this Change

Transfer 74AHC/T & 74VHC/T products into released and mature C125 process at ICN8 (NXP Semiconductors Nijmegen The Netherlands) and ASMC (Advanced Semiconductor Manufacturing Corporation Limited in Shanghai China) diffusion fabs

- No change in data sheet
- No assembly location changes
- No test/packing location changes
- No change in ordering part number / 12NC

Why do we Implement this Change

- Reduce risk of supply by releasing in geographically dispersed production locations
- To support increased customer demand

Identification of Affected Products

- Applied wafer fab is indicated on the reel and box label or on the product marking if space permits

Fab indicators:

"Y"= ASMC, Shanghai, China

"T"= NXP ICN8, Nijmegen, Netherlands

Product Availability

Sample Information

Samples are available upon request

Available in Logic sample store Nijmegen The Netherlands

Samples request for limited quantities can be made via sample store Nijmegen The Netherlands

Production

Planned first shipment 25-Dec-2015

Impact

- No impact to the product's quality/functionality anticipated
- Die design tuned to match current product performance
- Using state of the art process will reduce spread

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 12-Oct-2015.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Emile Busink

Position PCN specialist - QA engineering Logic Products

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possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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